

AMENDMENTS TO THE DRAWINGS

Applicant submits herewith one formal replacement sheet of drawings for Figure 9.

Attachment: 1 Replacement Sheet

REMARKS

Claims 11 and 12 have been examined and have been rejected under 35 U.S.C. § 103(a).

I. Preliminary Matters

Applicant submits herewith a formal replacement sheet for Figure 9. In the figure, reference numeral “4” has been changed to reference numeral “7” in conformance with the disclosure in the specification. No new matter has been added.

Also, Applicant has canceled withdrawn claims 19-24 and 42-46 without prejudice or disclaimer.

II. Rejections under 35 U.S.C. § 103(a) as being unpatentable over Hou (U.S. Pat. No. 6,113,810) in view of Liang (U.S. Pat. No. 2004/0263946).

The Examiner has rejected claims 11 and 12 under 35 U.S.C. § 103(a) as allegedly being unpatentable over Hou in view of Liang.

A. Claim 11

Applicant submits that claim 11 is patentable over the cited references. For example, claim 11 recites, “wherein the two opposed substrates of the image display panel are connected with a thermosetting adhesive or a photo-curing adhesive, and wherein the thermosetting adhesive or the photo-curing adhesive connects the two opposed substrates by directly contacting both of the two opposed substrates.” In regard to the claimed feature, Applicant refers the Examiner to Figure 13(c) of the present Application, where the adhesive 33 directly contacts and therefore connects the substrate 1 with the substrate 2.

Turning to the rejection, the Examiner acknowledges that Hou fails to disclose the claimed adhesive, but contends that Liang does. Liang, however, merely discloses use of an adhesive, i.e., adhesive layer 28, for lamination of the sealed microcups. As disclosed in paragraphs [0028], [0029] and [0067], the layer 21 contains an insulator layer 27 and an adhesive layer 28 to laminate the sealed cells. Assuming *arguendo* that layer 27 discloses a first substrate and layer 25 discloses a second opposed substrate, Liang fails to teach or suggest that the adhesive layer 28 actually contacts both of layers 25 and 27 (see Fig. 1). Since the adhesive layer 28 is merely used to adhere the insulator layer 27 to the sealing layer 26 of the microcup, the layer thus only directly contacts one of the alleged substrates. Accordingly, the adhesive layer of Liang fails to disclose the claimed adhesive (i.e., thermosetting adhesive or photo-curing adhesive).

In view of the above, Applicant submits that even if there was motivation to provide the adhesive layer 28 of Liang in the display of Hou, such combination would fail to teach or suggest the claimed invention.

B. Claim 12

Applicant submits that claim 12 is patentable at least by virtue of its dependency.

III. Newly Added Claim

By this Amendment, Applicant has added claims 47-49 to provide more varied protection of the present invention. Applicant submits that the newly added claims read on the elected species. In particular, Applicant elected species IV, where the Examiner identifies species IV as

directed to the first embodiment, fourth aspect. On pages 77 and 78 of the present Application, Figures 13(a)-13(c) and the partition walls 7 are discussed in regard to the first embodiment, fourth aspect.

Furthermore, in regard to claims 48 and 49, Applicant submits that the alleged adhesive 28 of Liang is not disposed on an external surface of a partition wall, where the external surface extends between the two opposed substrates. In this regard, Applicant refers the Examiner to Figure 13(c) of the present Application. As shown therein, the adhesive 33 is provided on an external surface of the partition wall 7, where the external surface extends between substrates 1 and 2. On the other hand, the alleged adhesive 28 of Liang is merely provided on top of the sealing layer 26, such that it runs parallel to the alleged substrates 25 and 27. In other words, the alleged adhesive 28 of Liang is not provided on an external surface of a partition wall that extends between alleged substrates 25 and 27. Accordingly, Applicant submits that claims 48 and 49 are patentable over the cited references.

IV. Conclusion

In view of the above, reconsideration and allowance of this application are now believed to be in order, and such actions are hereby solicited. If any points remain in issue which the Examiner feels may be best resolved through a personal or telephone interview, the Examiner is kindly requested to contact the undersigned at the telephone number listed below.

The USPTO is directed and authorized to charge all required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any

overpayments to said Deposit Account.

Respectfully submitted,


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